

DS0026/DS0056 5 MHz Two Phase MOS Clock Drivers

General Description

DS0026/DS0056 are low cost monolithic high speed two phase MOS clock drivers and interface circuits. Unique circuit design provides both very high speed operation and the ability to drive large capacitive loads. The device accepts standard TTL outputs and converts them to MOS logic levels. They may be driven from standard 54/74 series and 54S/74S series gates and flip-flops or from drivers such as the DS8830 or DM7440. The DS0026 and DS0056 are intended for applications in which the output pulse width is logically controlled; i.e., the output pulse width is equal to the input pulse width.

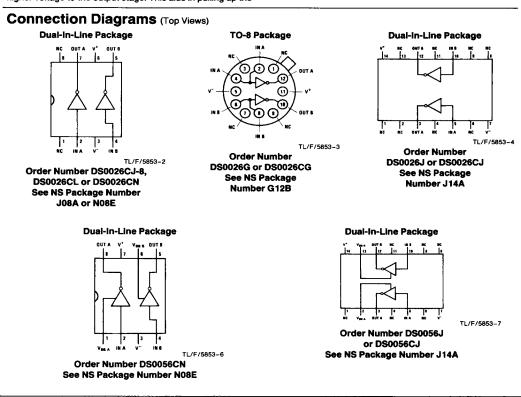
The DS0026/DS0056 are designed to fulfill a wide variety of MOS interface requirements. As a MOS clock driver for long silicon-gate shift registers, a single device can drive over 10k bits at 5 MHz. Six devices provide input address and precharge drive for a 8k by 16-bit 1103 RAM memory system. Information on the correct usage of the DS0026 in these as well as other systems is included in the application note AN-76.

The DS0026 and DS0056 are identical except each driver in the DS0056 is provided with a V_{BB} connection to supply a higher voltage to the output stage. This aids in pulling up the

output when it is in the high state. An external resistor tied between these extra pins and a supply higher than V+ will cause the output to pull up to (V+ - 0.1V) in the off state. For DS0056 applications, it is required that an external resistor be used to prevent damage to the device when the driver switches low. A typical V_{BB} connection is shown on the next page.

Features

- Fast rise and fall times--20 ns 1000 pF load
- High output swing—20V
- High output current drive—±1.5 amps
- TTL compatible inputs
- High rep rate—5 to 10 MHz depending on power dissipation
- Low power consumption in MOS "0" state—2 mW
- Drives to 0.4V of GND for RAM address drive



800 mW

-55°C to +125°C

-65°C to +150°C

0°C to +70°C

Absolute Maximum Ratings (Note 1)

V+ ~ V- Differential Voltage

Molded Package

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Input Current	100 mA
Input Voltage (V _{IN} - V ⁻)	5.5V
Peak Output Current	1.5A
Maximum Power Dissipation* at 25°C	
Cavity Package (8-Pin)	1150 mW
Cavity Package (14-Pin)	1380 mW

Storage Temperature Range
Lead Temperature (Soldering, 10 sec.)

* Derate 8-pin cavity package 7.7 mW/°C above package 9.3 mW/°C above 25°C: derate molecular molecula

Operating Temperature Range

EIAJ SO Package

DS0026, DS0056

DS0026C, DS0056C

 Derate 8-pin cavity package 7.7 mW/*C above 25°C; derate 14-pin cavity package 9.3 mW/*C above 25°C; derate molded package 8.4 mW/*C above 25°C; derate metal can (TO-5) package 4.4 mW/*C above 25°C; derate EIAJ SO package 5.5 mW/*C above 25°C.

Electrical Characteristics (Notes 2 and 3)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
V _{IH}	Logic "1" Input Voltage	V- = 0V	2	1.5		V	
l _{IH}	Logic "1" Input Current	$V_{IN} - V^{-} = 2.4V$			10	15	mA
V _{IL}	Logic "0" Input Voltage	V- = 0V			0.6	0.4	v
l _{IL}	Logic "0" Input Current	$V_{IN} - V^- = 0V$			-3	10	μА
VOL	Logic "1" Output Voltage	$V_{IN} - V^- = 2.4V, I_{OL} = 1 \text{ mA}$			V-+0.7	V-+1.0	V
V _{OH}	Logic "0" Output Voltage	$V_{IN} - V^- = 0.4V, V_{SS} \ge V^+ + 1.0V$	DS0026	V+ - 1.0	V+-0.8		V
		I _{OH} = - 1 mA	DS0056	V+-0.3	V+-0.1		V
I _{CC(ON)}	"ON" Supply Current	$V^+ - V^- = 20V, V_{IN} - V^- = 2.4V$	DS0026		30	40	mA
	(one side on)	(Note 6)	DS0056		12	30	mA
I _{CC(OFF)}	"OFF" Supply Current	$V^{+} - V^{-} = 20V,$	70°C		10	100	μА
		$V_{IN} - V^- = 0V$ 125°C			10	500	μА

1040 mW

Switching Characteristics (T_A = 25°C) (Notes 5 and 7)

Symbol	Parameter	Conditions		Min	Тур	Max	Units	
ton	Turn-On Delay	(Figure 1)		5	7.5	12	ns	
		(Figure 2)			11		ns	
^t OFF	Turn-Off Delay	(Figure 1)			12	15	ns	
		(Figure 2)			13		ns	
t _r	Rise Time	(Figure 1),	C _L = 500 pF		15	18	ns	
		(Note 5)	C _L = 1000 pF		20	35	ns	
		(Figure 2)	(Figure 2),	C _L = 500 pF		30	40	ns
		(Note 5)	C _L = 1000 pF		36	50	ns	
t _f	(Note:	(Figure 1),	C _L = 500 pF		12	16	ns	
		(Note 5)	C _L = 1000 pF		17	25	ns	
		(Figure 2),	C _L = 500 pF		28	35	ns	
		(Note 5)	C _L = 1000 pF		31	40	ns	

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics provides conditions for actual device operation.

Note 2: These specifications apply for $V^+ - V^- = 10V$ to 20V, $C_L = 1000$ pF, over the temperature range of -55° C to $+125^{\circ}$ C for the DS0026, DS0056 and 0° C to $+70^{\circ}$ C for the DS0026C, DS0056C.

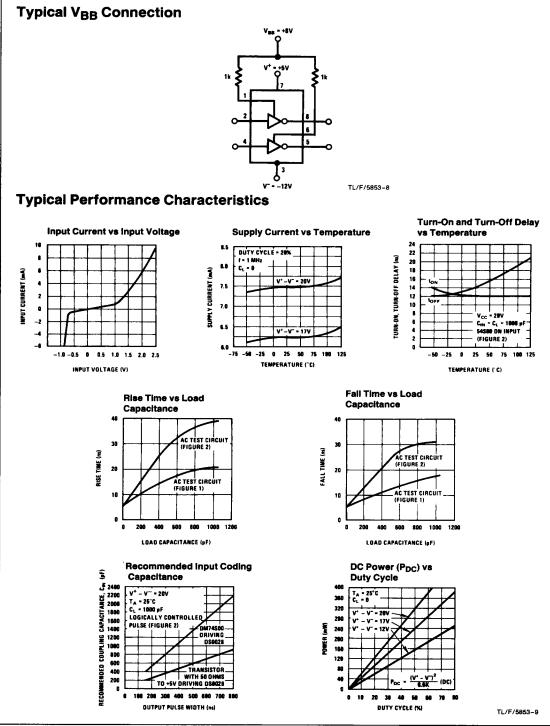
Note 3: All currents into device pins shown as positive, out of device pins as negative, all voltages referenced to ground unless otherwise noted. All values shown as max or min on absolute value basis.

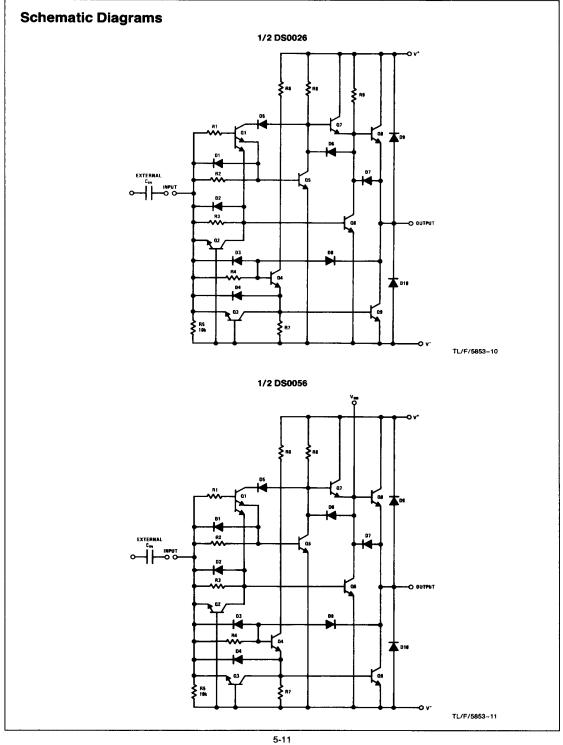
Note 4: All typical values for $T_A = 25^{\circ}C$

Note 5: Rise and fall time are given for MOS logic levels; i.e., rise time is transition from logic "0" to logic "1" which is voltage fall.

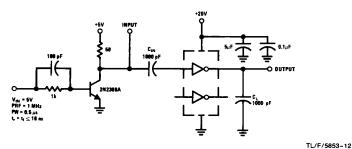
Note 6: I_{BB} for DS0056 is approximately ($V_{BB} - V^-$)/1 k Ω (for one side) when output is low.

Note 7: The high current transient (as high as 1.5A) through the resistance of the internal interconnecting V = lead during the output transition from the high state to the low state can appear as negative feedback to the input. If the external interconnecting lead from the driving circuit to V = is electrically long, or has significant do resistance, it can subtract from the switching response.





AC Test Circuits and Switching Time Waveforms



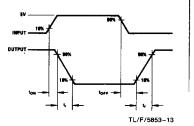
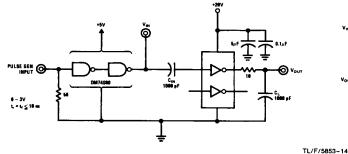


FIGURE 1



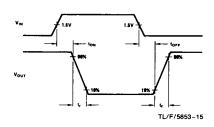
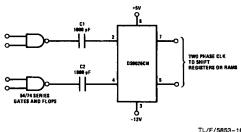


FIGURE 2

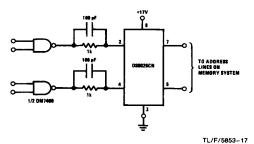
Typical Applications

AC Coupled MOS Clock Driver



TL/F/5853-16

DC Coupled RAM Memory Address or Precharge **Driver (Positive Supply Only)**



Application Hints

DRIVING THE MM5262 WITH THE DS0056 CLOCK DRIVER

The clock signals for the MM5262 have three requirements which have the potential of generating problems for the user. These requirements, high speed, large voltage swing and large capacitive loads, combine to provide ample opportunity for inductive ringing on clock lines, coupling clock signals to other clocks and/or inputs and outputs and generating noise on the power supplies. All of these problems

have the potential of causing the memory system to malfunction. Recognizing the source and potential of these problems early in the design of a memory system is the most critical step. The object here is to point out the source of these problems and give a quantitative feel for their magnitude.

Application Hints (Continued)

Line ringing comes from the fact that at a high enough frequency any line must be considered as a transmission line with distributed inductance and capacitance. To see how much ringing can be tolerated we must examine the clock voltage specification. *Figure 6* shows the clock specification, in diagram form, with idealized ringing sketched in. The

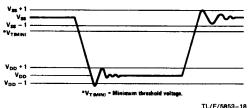


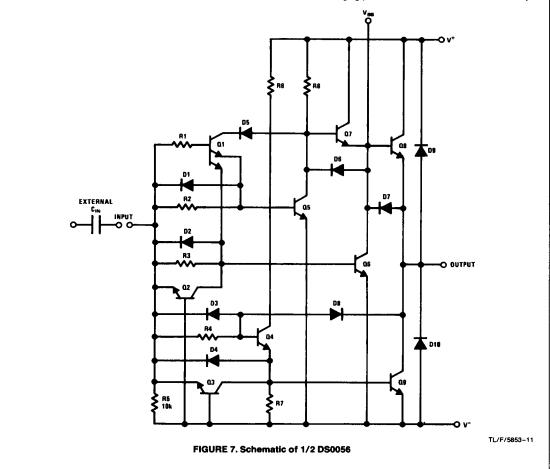
FIGURE 6. Clock Waveform

ringing of the clock about the V_{SS} level is particularly critical. If the $V_{SS}-1$ V_{OH} is not maintained, at *all* times, the infor-

mation stored in the memory could be altered. Referring to Figure 1, if the threshold voltage of a transistor were -1.3V, the clock going to $V_{\rm SS} - 1$ would mean that all the devices, whose gates are tied to that clock, would be only 300 mV from turning on. The internal circuitry needs this noise margin and from the functional description of the RAM it is easy to see that turning a clock on at the wrong time can have disastrous results.

Controlling the clock ringing is particularly difficult because of the relative magnitude of the allowable ringing, compared to magnitude of the transition. In this case it is 1V out of 20V or only 5%. Ringing can be controlled by damping the clock driver and minimizing the line inductance.

Damping the clock driver by placing a resistance in series with its output is effective, but there is a limit since it also slows down the rise and fall time of the clock signal. Because the typical clock driver can be much faster than the worst case driver, the damping resistor serves the useful function of limiting the minimum rise and fall time. This is very important because the faster the rise and fall times, the worse the ringing problem becomes. The size of the damp-



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Application Hints (Continued)

ing resistor varies because it is dependent on the details of the actual application. It must be determined empirically. In practice a resistance of 10Ω to 20Ω is usually optimum,

Limiting the inductance of the clock lines can be accomplished by minimizing their length and by laying out the lines such that the return current is closely coupled to the clock lines. When minimizing the length of clock lines it is important to minimize the distance from the clock driver output to the furthest point being driven. Because of this, memory boards are usually designed with clock drivers in the center of the memory array, rather than on one side, reducing the maximum distance by a factor of 2.

Using multilayer printed circuit boards with clock lines sandwiched between the $V_{\rm DD}$ and $V_{\rm SS}$ power plains minimizes the inductance of the clock lines. It also serves the function of preventing the clocks from coupling noise into input and output lines. Unfortunately multilayer printed circuit boards are more expensive than two sided boards. The user must make the decision as to the necessity of multilayer boards. Suffice it to say here, that reliable memory boards can be designed using two sided printed circuit boards.

The recommended clock driver for use with the MM4262/MM5262 is the DS0056/DS0056C dual clock driver. This device is designed specifically for use with dynamic circuits using a substrate, V_{BB}, supply. Typically it will drive a 1000 pF load with 20 ns rise and fall times. *Figure 7* shows a schematic of a single driver.

In the case of the MM5262, V+ is a +5V and V_{BB} is +8.5V. V_{BB} should be connected to the V_{BB} pin shown in Figure 7 through a 1 k Ω resistor. This allows transistor Q8 to

 V_{OUT} -15V

20 ns

-1 AMP

-1 AMP

-1 AMP

-1 L

FIGURE 8. Clock Waveforms (Voltage and Current)

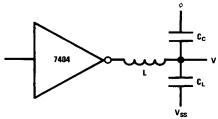
saturate, pulling the output to within a $V_{CE(SAT)}$ of the V+ supply. This is critical because as was shown before, the $V_{SS} - 1.0V$ clock level must not be exceeded at any time. Without the V_{BB} pull up on the base of Q8 the output at best will be 0.6V below the V+ supply and can be 1V below the V+ supply reducing the noise margin on this line to zero.

Because of the amount of current that the clock driver must supply to its capacitive load, the distribution of power to the clock driver must be considered. *Figure 8* gives the idealized voltage and current waveforms for a clock driver driving a 1000 pF capacitor with 20 ns rise and fall time.

As can be seen the current is significant. This current flows in the V $_{DD}$ and V $_{SS}$ power lines. Any significant inductance in the lines will produce large voltage transients on the power supplies. A bypass capacitor, as close as possible to the clock driver, is helpful in minimizing this problem. This bypass is most effective when connected between the V $_{SS}$ and V $_{DD}$ supplies. A bypass capacitor for each DS0056 is recommended. The size of the bypass capacitor depends on the amount of capacitance being driven. Using a low inductance capacitor, such as a ceramic or silver mica, is most effective. Another helpful technique is to run the V $_{DD}$ and V $_{SS}$ lines, to the clock driver, adjacent to each other. This tends to reduce the lines inductance and therefore the magnitude of the voltage transients.

While discussing the clock driver, it should be pointed out that the DS0056 is a relatively low input impedance device. It is possible to couple current noise into the input without seeing a significant voltage. Since the noise is difficult to detect with an oscilloscope it is often overlooked.

Lastly, the clock lines must be considered as noise generators. Figure 9 shows a clock coupled through a parasitic coupling capacitor, $C_{\rm C}$, to eight data input lines being driven by a 7404. A parasitic lumped line inductance, L, is also shown. Let us assume, for the sake of argument, that $C_{\rm C}$ is 1 pF and that the rise time of the clock is high enough to completely isolate the clock transient from the 7404 because of the inductance, L.



TL/F/5853-20

FIGURE 9. Clock Coupling

With a clock transition of 20V the magnitude of the voltage generated across C_{L} is:

$$V = 20V \times \frac{C_C}{C_L + C_C} = 20V \times \left(\frac{1}{56 + 1}\right) = 0.35V$$

This has been a hypothetical example to emphasize that with 20V low rise/fall time transitions, parasitic elements can not be neglected. In this example, 1 pF of parasitic capacitance could cause system malfunction, because a 7404 without a pull up resistor has typically only 0.3V of

Application Hints (Continued)

noise margin in the "1" state at 25°C. Of course it is stretching things to assume that the inductance, L, completely isolates the clock transient from the 7404. However, it does point out the need to minimize inductance in input/output as well as clock lines.

The output is current, so it is more meaningful to examine the current that is coupled through a 1 pF parasitic capacitance. The current would be:

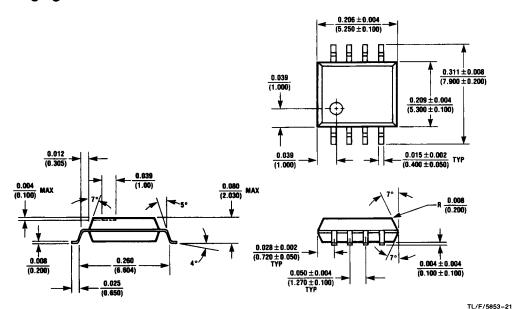
$$I=C_C\times\frac{\Delta V}{\Delta t}=\frac{1\times10^{-12}\times20}{20\times10^{-9}}=1~\text{mA}$$

This exceeds the total output current swing so it is obviously significant.

Clock coupling to inputs and outputs can be minimized by using multilayer printed circuit boards, as mentioned previously, physically isolating clock lines and/or running clock lines at right angles to input/output lines. All of these techniques tend to minimize parasitic coupling capacitance from the clocks to the signals in guestion.

In considering clock coupling it is also important to have a detailed knowledge of the functional characteristics of the device being used. As an example, for the MM5262, coupling noise from the $\phi 2$ clock to the address lines is of no particular consequence. On the other hand the address inputs will be sensitive to noise coupled from $\phi 1$ clock.

Packaging Information



8-Lead Surface Mount Package Order Number DS0026CL